

DATASHEET

UJ3N120065K3S

1200V-66mΩ SiC Normally-on JFET

Rev. A, November 2019

Description

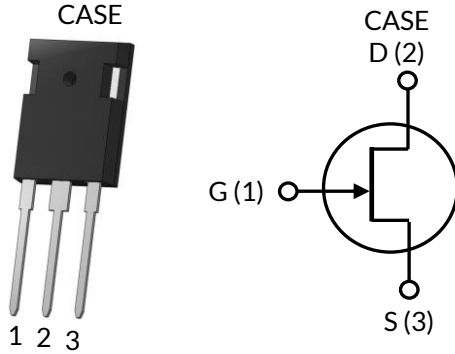
UnitedSiC offers the high-performance G3 SiC normally-on JFET transistors. This series exhibits ultra-low on resistance ($R_{DS(ON)}$) and gate charge (Q_G) allowing for low conduction and switching loss. The device normally-on characteristics with low $R_{DS(ON)}$ at $V_{GS} = 0V$ is also ideal for current protection circuits without the need for active control, as well as for cascode operation.

Features

- ◆ Typical on-resistance $R_{DS(on),typ}$ of 66mΩ
- ◆ Voltage controlled
- ◆ Maximum operating temperature of 175°C
- ◆ Extremely fast switching not dependent on temperature
- ◆ Low gate charge
- ◆ Low intrinsic capacitance
- ◆ RoHS compliant

Typical applications

- ◆ Over Current Protection Circuits
- ◆ DC-AC Inverters
- ◆ Switch mode power supplies
- ◆ Power factor correction modules
- ◆ Motor drives
- ◆ Induction heating



Part Number	Package	Marking
UJ3N120065K3S	TO-247-3L	UJ3N120065K3S



Maximum Ratings

Parameter	Symbol	Test Conditions	Value	Units
Drain-source voltage	V_{DS}		1200	V
Gate-source voltage	V_{GS}	DC	-20 to +3	V
		AC ¹	-30 to +20	V
Continuous drain current ²	I_D	$T_C = 25^\circ\text{C}$	34	A
		$T_C = 100^\circ\text{C}$	25	A
Pulsed drain current ³	I_{DM}	$T_C = 25^\circ\text{C}$	90	A
Power dissipation	P_{tot}	$T_C = 25^\circ\text{C}$	254	W
Maximum junction temperature	$T_{J,max}$		175	$^\circ\text{C}$
Operating and storage temperature	T_J, T_{STG}		-55 to 175	$^\circ\text{C}$
Max. lead temperature for soldering, 1/8" from case for 5 seconds	T_L		250	$^\circ\text{C}$

1. +20V AC rating applies for turn-on pulses <200ns applied with external $R_G > 1\Omega$.

2. Limited by $T_{J,max}$

3. Pulse width t_p limited by $T_{J,max}$

Thermal Characteristics

Parameter	Symbol	Test Conditions	Value			Units
			Min	Typ	Max	
Thermal resistance, junction-to-case	$R_{\theta JC}$			0.45	0.59	$^\circ\text{C/W}$

Electrical Characteristics ($T_J = +25^\circ\text{C}$ unless otherwise specified)

Typical Performance - Static

Parameter	Symbol	Test Conditions	Value			Units
			Min	Typ	Max	
Drain-source breakdown voltage	BV_{DS}	$V_{GS}=-20\text{V}, I_D=1\text{mA}$	1200			V
Total drain leakage current	I_{DSS}	$V_{DS}=1200\text{V}, V_{GS}=-20\text{V}, T_J=25^\circ\text{C}$		5	30	μA
		$V_{DS}=1200\text{V}, V_{GS}=-20\text{V}, T_J=175^\circ\text{C}$		56		
Total gate leakage current	I_{GSS}	$V_{GS}=-20\text{V}, T_J=25^\circ\text{C}$		0.1	50	μA
		$V_{GS}=-20\text{V}, T_J=175^\circ\text{C}$		1		μA
Drain-source on-resistance	$R_{DS(on)}$	$V_{GS}=2\text{V}, I_D=10\text{A}, T_J=25^\circ\text{C}$		55		m Ω
		$V_{GS}=0\text{V}, I_D=10\text{A}, T_J=25^\circ\text{C}$		66	90	
		$V_{GS}=2\text{V}, I_D=10\text{A}, T_J=175^\circ\text{C}$		122		
		$V_{GS}=0\text{V}, I_D=10\text{A}, T_J=175^\circ\text{C}$		142		
Gate threshold voltage	$V_{G(th)}$	$V_{DS}=5\text{V}, I_D=35\text{mA}$	-9.3	-6.6	-4.7	V
Gate resistance	R_G	f=1MHz, open drain		2.6		Ω

Typical Performance - Dynamic

Parameter	Symbol	Test Conditions	Value			Units
			Min	Typ	Max	
Input capacitance	C_{iss}	$V_{DS}=100V, V_{GS}=-20V$ $f=100kHz$		1008		pF
Output capacitance	C_{oss}			100		
Reverse transfer capacitance	C_{rss}			95		
Effective output capacitance, energy related	$C_{oss(er)}$	$V_{DS}=0V$ to 800V, $V_{GS}=-20V$		56		pF
C_{oss} stored energy	E_{oss}	$V_{DS}=800V, V_{GS}=-20V$		18		μJ
Total gate charge	Q_G	$V_{DS}=800V, I_D=25A,$ $V_{GS} = -18V$ to 0V		114		nC
Gate-drain charge	Q_{GD}			75		
Gate-source charge	Q_{GS}			16		
Turn-on delay time	$t_{d(on)}$	$V_{DS}=800V, I_D=25A,$ Gate Driver = -18V to 0V, $R_G=1\Omega,$ Inductive Load, FWD: UJ2D1215T $T_J=25^\circ C$		32		ns
Rise time	t_r			43		
Turn-off delay time	$t_{d(off)}$			19		
Fall time	t_f			16		
Turn-on energy	E_{ON}			785		
Turn-off energy	E_{OFF}		150		μJ	
Total switching energy	E_{TOTAL}		935			
Turn-on delay time	$t_{d(on)}$	$V_{DS}=800V, I_D=25A,$ Gate Driver = -18V to 0V, $R_G=1\Omega,$ Inductive Load, FWD: UJ2D1215T $T_J=150^\circ C$		28		ns
Rise time	t_r			42		
Turn-off delay time	$t_{d(off)}$			18		
Fall time	t_f			15		
Turn-on energy	E_{ON}			730		
Turn-off energy	E_{OFF}		146		μJ	
Total switching energy	E_{TOTAL}		876			

Typical Performance Diagrams

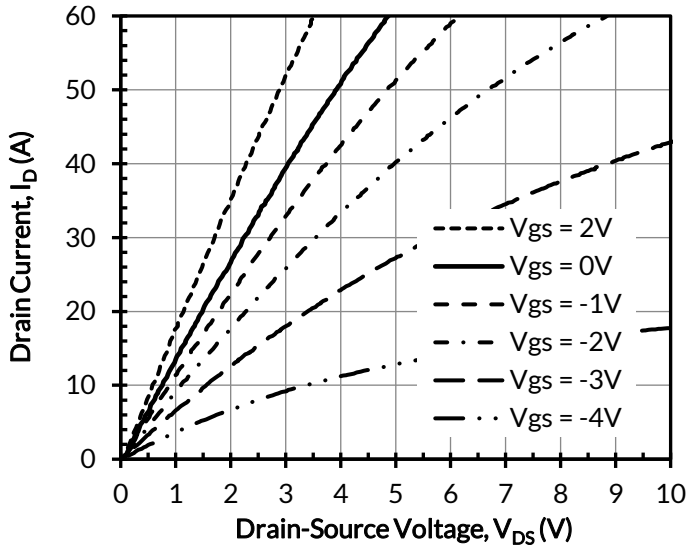


Figure 1. Typical output characteristics at $T_j = -55^\circ\text{C}$, $t_p < 250\mu\text{s}$

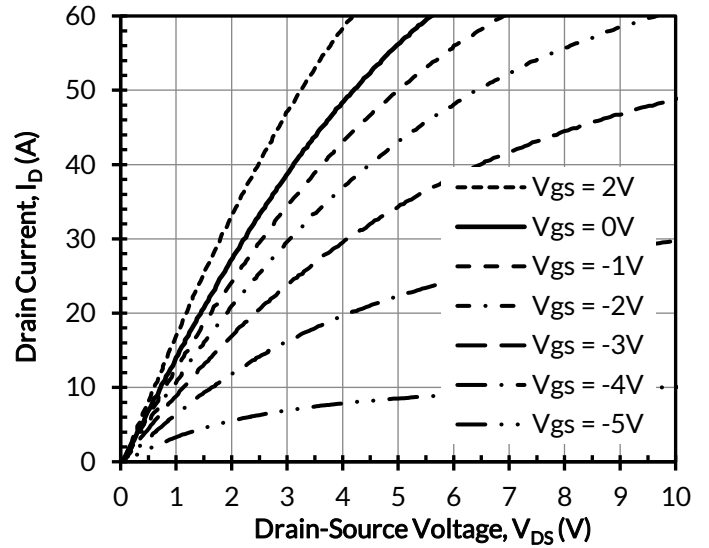


Figure 2. Typical output characteristics at $T_j = 25^\circ\text{C}$, $t_p < 250\mu\text{s}$

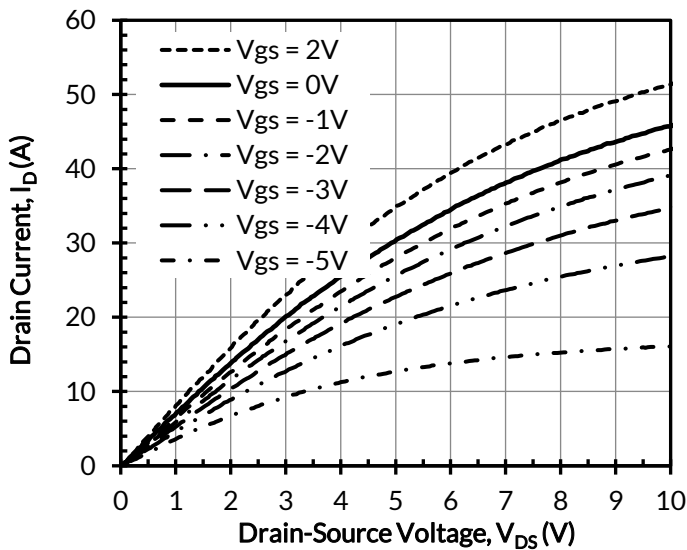


Figure 3. Typical output characteristics at $T_j = 175^\circ\text{C}$, $t_p < 250\mu\text{s}$

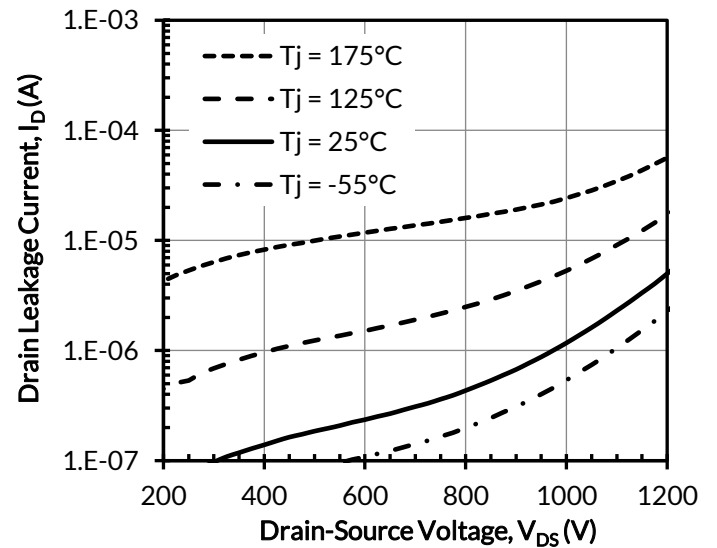


Figure 4. Typical drain-source leakage at $V_{GS} = -20\text{V}$

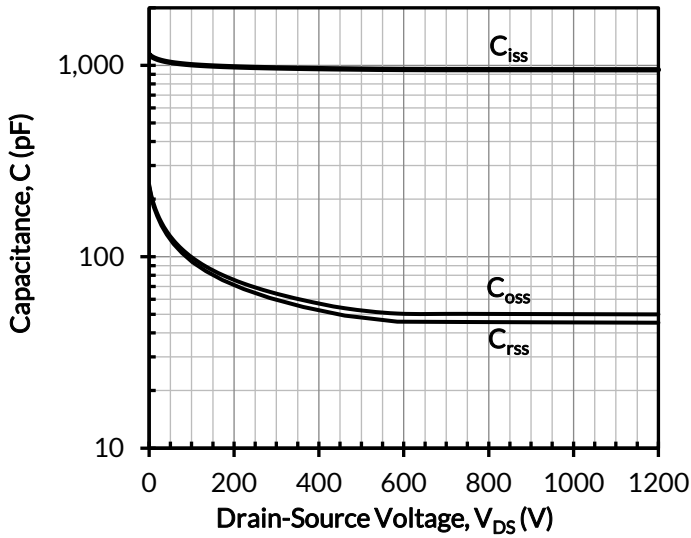


Figure 5. Typical capacitances at $f = 100\text{kHz}$ and $V_{GS} = -20\text{V}$

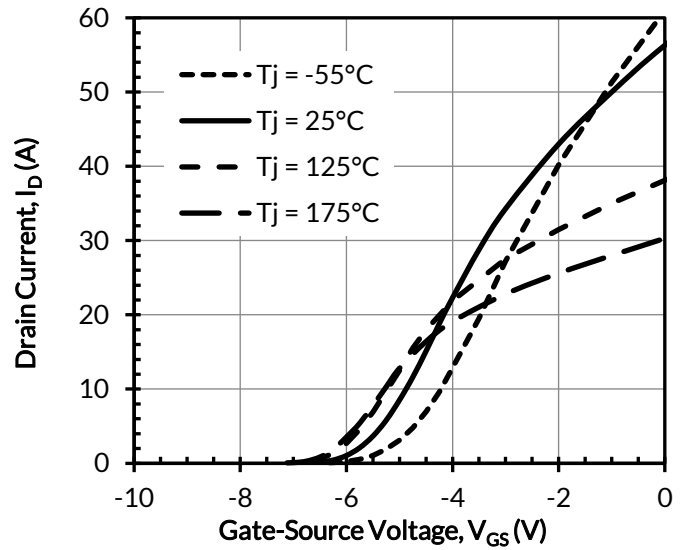


Figure 6. Typical transfer characteristics at $V_{DS} = 5\text{V}$

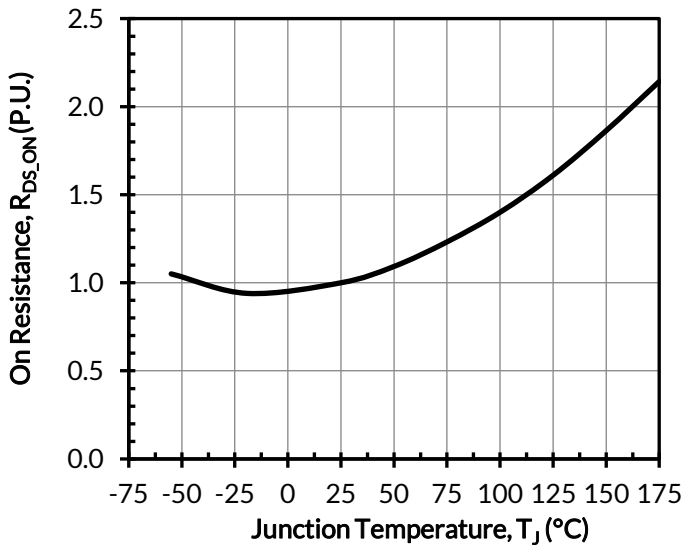


Figure 7. Normalized on-resistance vs. temperature at $V_{GS} = 0\text{V}$ and $I_D = 10\text{A}$

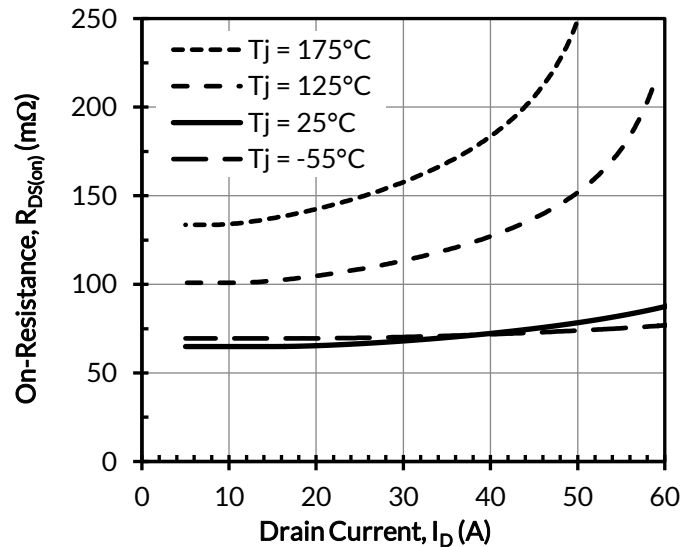


Figure 8. Typical drain-source on-resistances at $V_{GS} = 0\text{V}$

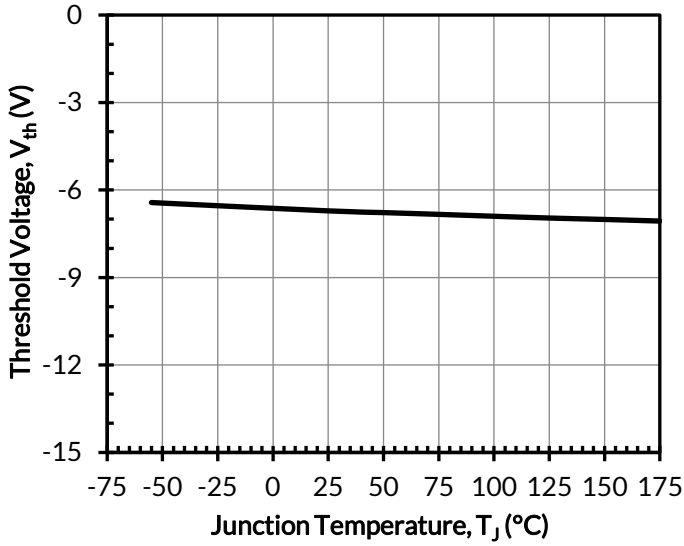


Figure 9. Threshold voltage vs. junction temperature at $V_{DS} = 5V$ and $I_D = 35mA$

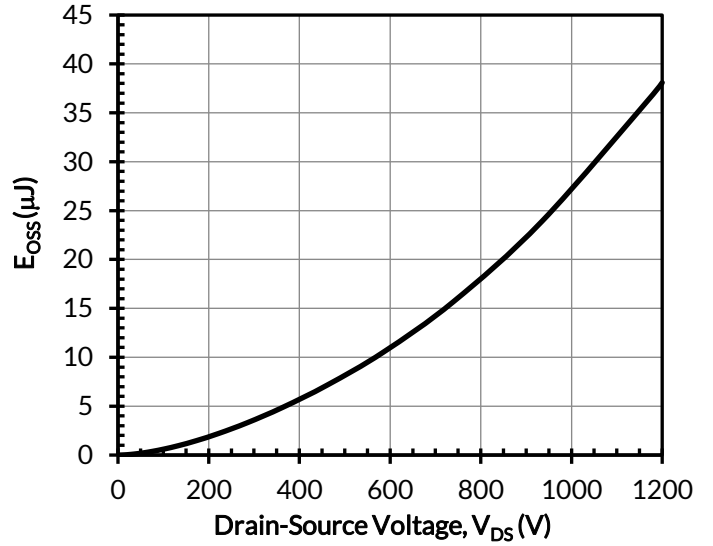


Figure 10. Typical stored energy in C_{OSS} at $V_{GS} = -20V$

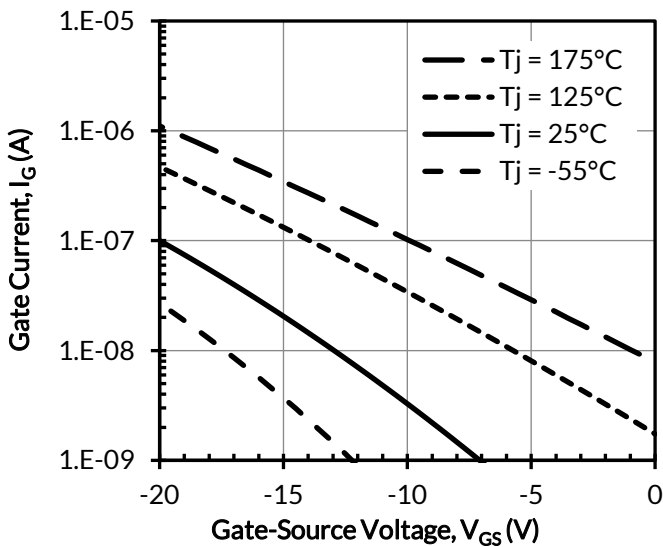


Figure 11. Typical gate leakage at $V_{DS} = 0V$

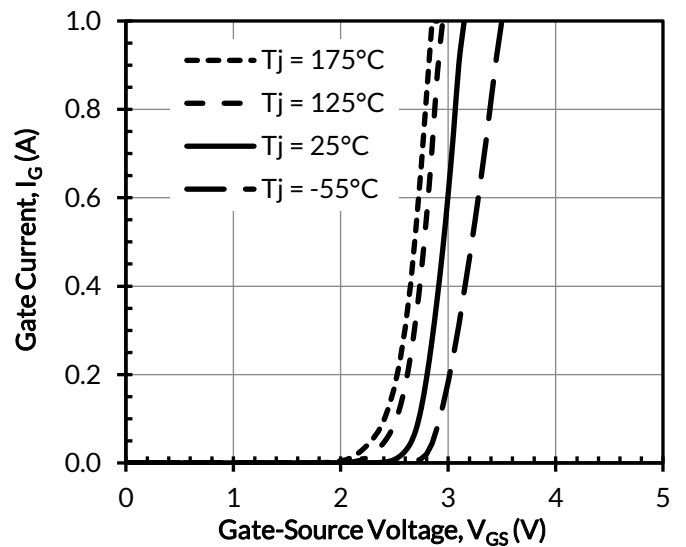


Figure 12. Typical gate forward current at $V_{DS} = 0V$

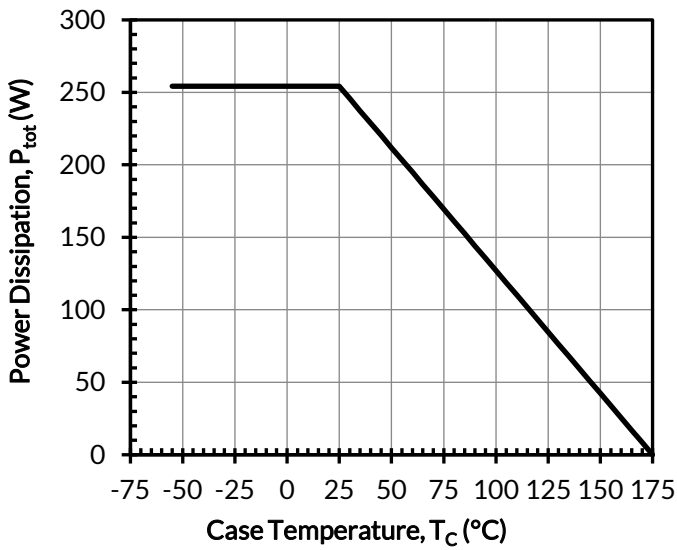


Figure 13. Total power Dissipation

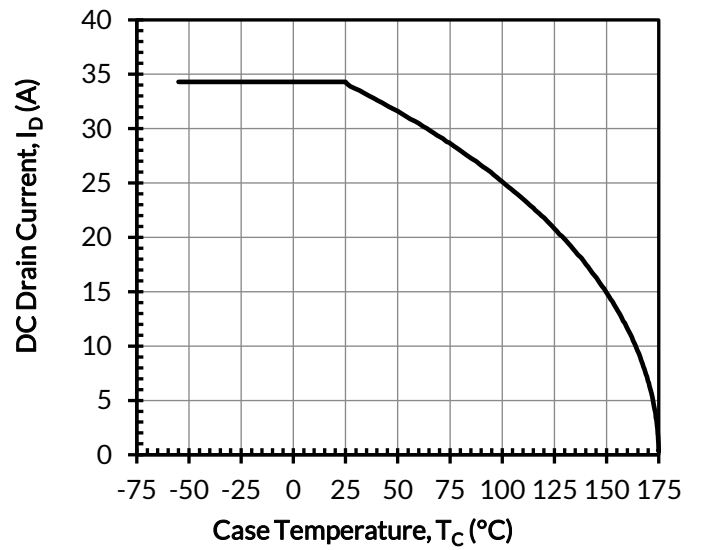


Figure 14. DC drain current derating

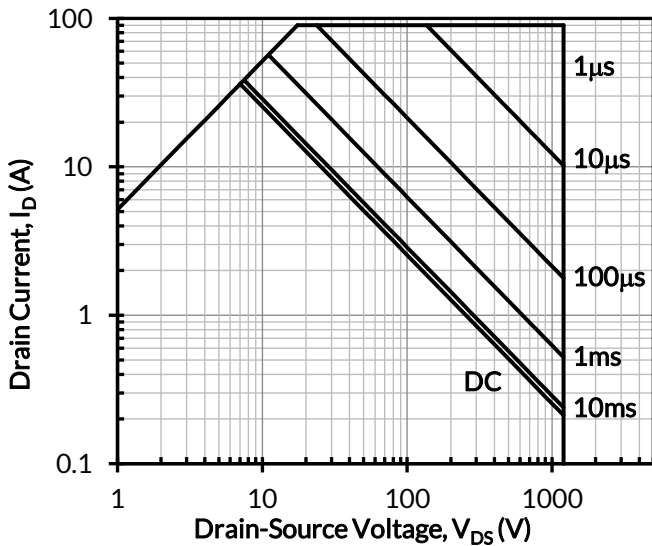


Figure 15. Safe operation area at $T_C = 25^\circ\text{C}$, Parameter t_p

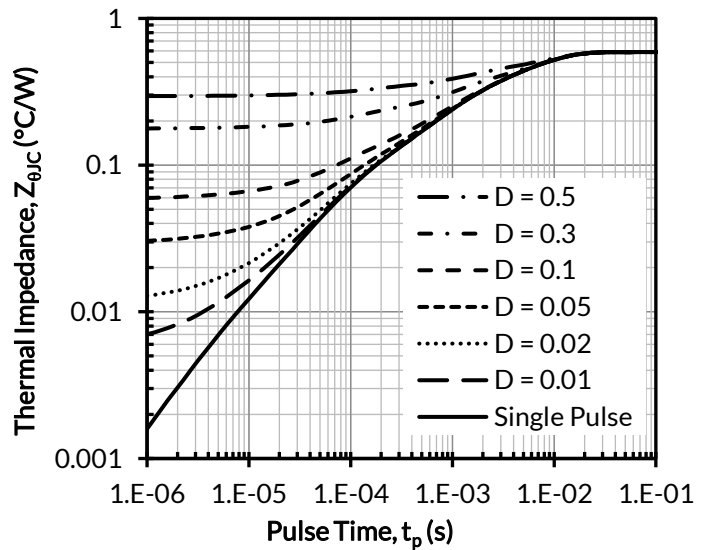


Figure 16. Maximum transient thermal impedance

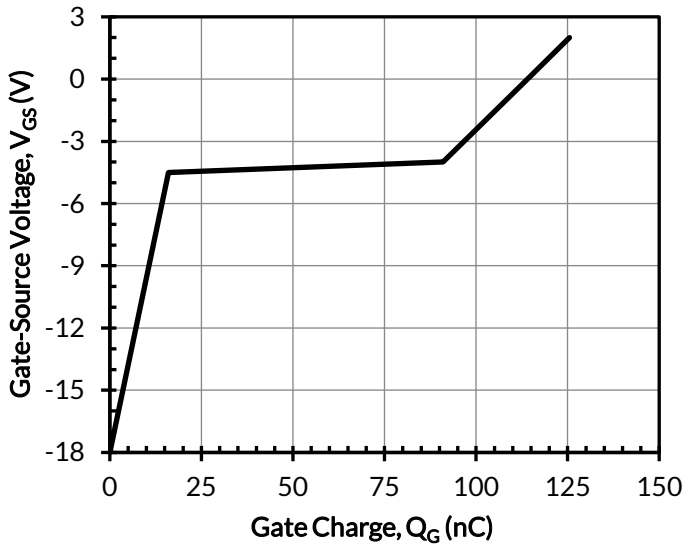


Figure 17. Typical gate charge at $V_{DS} = 800V$ and $I_D = 25A$

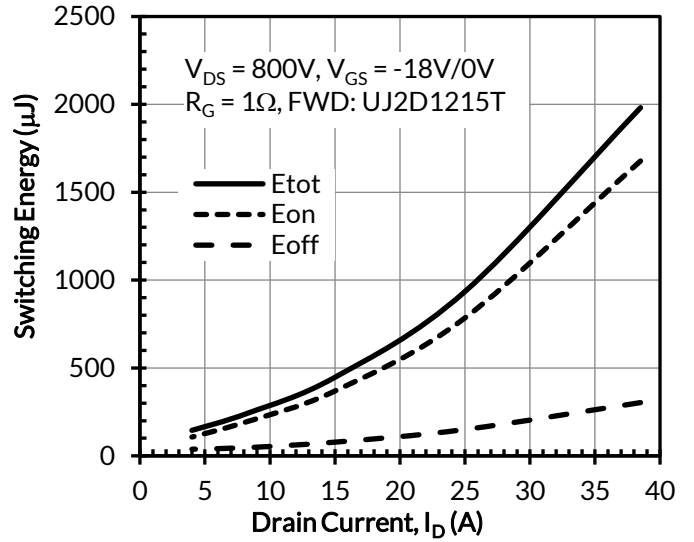


Figure 18. Clamped inductive switching energy vs. drain current at $T_J = 25^\circ C$

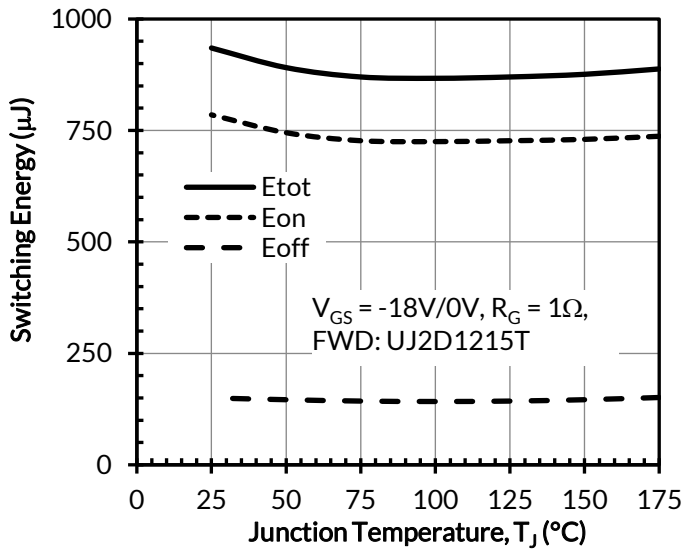


Figure 19. Clamped inductive switching energy vs. junction temperature at $V_{DS} = 800V$ and $I_D = 25A$

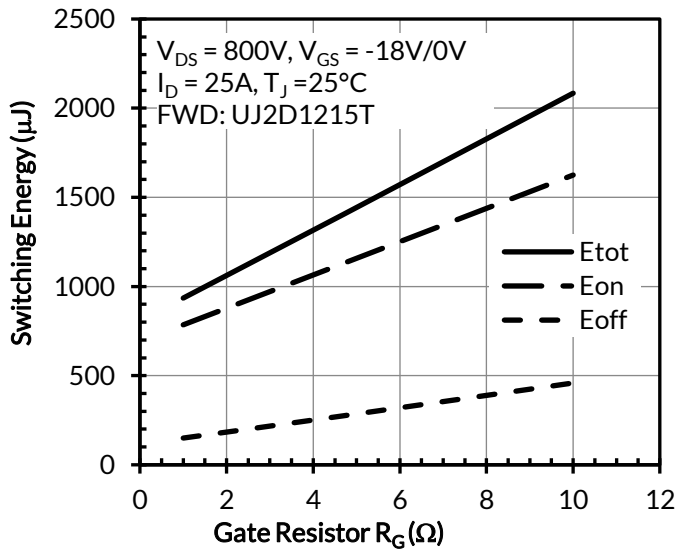


Figure 20. Clamped inductive switching energy vs. gate resistor R_G

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